# **Low-Voltage CMOS Quad Buffer**

# With 5V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX125 is a high performance, non-inverting quad buffer operating from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A VI specification of 5.5V allows MC74LCX125 inputs to be safely driven from 5V devices. The MC74LCX125 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24mA at the outputs. The Output Enable (OEn) inputs, when HIGH, disable the outputs by placing them in a HIGH Z condition.

- Designed for 2.7 to 3.6V VCC Operation
- 5V Tolerant Interface Capability With 5V TTL Logic
- Supports Live Insertion and Withdrawal
- IOFF Specification Guarantees High Impedance When VCC = 0V
- LVTTL Compatible
- LVCMOS Compatible
- 24mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V; Machine Model >200V

Pinout: 14-Lead (Top View)

## OE3 D3 OE2 D2 02 8 13

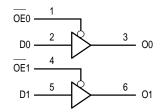
# OE1 **LOGIC DIAGRAM**

5

D1

6

01



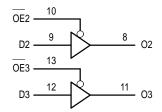
OE0

2

D0

3

00



GND

# **MC74LCX125**



### **LOW-VOLTAGE CMOS QUAD BUFFER**



# **D SUFFIX**

PLASTIC SOIC CASE 751A-03



#### **M SUFFIX**

PLASTIC SOIC EIAJ CASE 965-01



### **SD SUFFIX**

PLASTIC SSOP CASE 940A-03



#### **DT SUFFIX**

PLASTIC TSSOP CASE 948G-01

#### **PIN NAMES**

Pins	Function
OEn	Output Enable Inputs
Dn	Data Inputs
On	3–State Outputs

#### **FUNCTION TABLE**

INP	UTS	OUTPUTS
OEn	Dn	On
L L	L H	IT
Н	X	Z

 $H = High\ Voltage\ Level; L = Low\ Voltage\ Level; Z = High\ Impedance\ State;\ X = High\ or\ Low\ Voltage\ Level\ and\ Transitions\ Are\ Acceptable,\ for\ I_{CC}\ reasons,\ DO\ NOT\ FLOAT\ Inputs$ 

### MC74LCX125

#### **ABSOLUTE MAXIMUM RATINGS\***

Symbol	Parameter	Value	Condition	Unit
VCC	DC Supply Voltage	-0.5 to +7.0		V
VI	DC Input Voltage	-0.5 ≤ V <sub>I</sub> ≤ +7.0		V
VO	DC Output Voltage	$-0.5 \le V_{O} \le +7.0$	Output in 3–State	V
		$-0.5 \le V_{O} \le V_{CC} + 0.5$	Note 1.	V
lıK	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
lok	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
		+50	AO > ACC	mA
IO	DC Output Source/Sink Current	±50		mA
Icc	DC Supply Current Per Supply Pin	±100		mA
IGND	DC Ground Current Per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C

<sup>\*</sup> Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute—maximum—rated conditions is not implied.

1. Output in HIGH or LOW State. Io absolute maximum rating must be observed.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Тур	Max	Unit
VCC	Supply Voltage Operating Data Retention Only	2.0 1.5	3.3 3.3	3.6 3.6	V
VI	Input Voltage	0		5.5	V
Vo	Output Voltage (HIGH or LOW State) (3–State)	0 0		V <sub>CC</sub> 5.5	V
loн	HIGH Level Output Current, V <sub>CC</sub> = 3.0V – 3.6V			-24	mA
loL	LOW Level Output Current, V <sub>CC</sub> = 3.0V – 3.6V			24	mA
IOH	HIGH Level Output Current, V <sub>CC</sub> = 2.7V – 3.0V			-12	mA
loL	LOW Level Output Current, V <sub>CC</sub> = 2.7V - 3.0V			12	mA
TA	Operating Free–Air Temperature	-40		+85	°C
Δt/ΔV	Input Transition Rise or Fall Rate, $V_{IN}$ from 0.8V to 2.0V, $V_{CC} = 3.0V$	0		10	ns/V

#### DC ELECTRICAL CHARACTERISTICS

			T <sub>A</sub> = -40°C	C to +85°C	
Symbol	Characteristic	Condition	Min	Max	Unit
VIH	HIGH Level Input Voltage (Note 2.)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage (Note 2.)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V		0.8	V
Vон	HIGH Level Output Voltage	$2.7V \le V_{CC} \le 3.6V; I_{OH} = -100\mu A$	V <sub>CC</sub> - 0.2		V
		V <sub>CC</sub> = 2.7V; I <sub>OH</sub> = -12mA	2.2		
		V <sub>CC</sub> = 3.0V; I <sub>OH</sub> = -18mA	2.4		1
		$V_{CC} = 3.0V; I_{OH} = -24mA$	2.2		
VOL	LOW Level Output Voltage	$2.7V \le V_{CC} \le 3.6V; I_{OL} = 100\mu A$		0.2	V
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 12mA		0.4	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA		0.4	1
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 24mA		0.55	

<sup>2.</sup> These values of V<sub>I</sub> are used to test DC electrical characteristics only.

#### DC ELECTRICAL CHARACTERISTICS (continued)

			T <sub>A</sub> = -40°C	to +85°C	
Symbol	Characteristic	Condition	Min	Max	Unit
lį	Input Leakage Current	$2.7V \le V_{CC} \le 3.6V; 0V \le V_{I} \le 5.5V$		±5.0	μΑ
loz	3-State Output Current	$2.7 \le V_{CC} \le 3.6V$ ; $0V \le V_O \le 5.5V$ ; $V_I = V_{IH}$ or $V_{IL}$		±5.0	μΑ
loff	Power-Off Leakage Current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 5.5V$		10	μΑ
Icc	Quiescent Supply Current	$2.7 \le V_{CC} \le 3.6V$ ; $V_I = GND$ or $V_{CC}$		10	μΑ
		$2.7 \le V_{CC} \le 3.6V$ ; $3.6 \le V_I$ or $V_O \le 5.5V$		±10	μΑ
ΔlCC	Increase in I <sub>CC</sub> per Input	2.7 ≤ V <sub>CC</sub> ≤ 3.6V; V <sub>IH</sub> = V <sub>CC</sub> − 0.6V		500	μΑ

#### AC CHARACTERISTICS ( $t_R = t_F = 2.5$ ns; $C_L = 50$ pF; $R_L = 500\Omega$ )

				Limits		
			TA	_ = −40°C to +	-85°C	1
			V <sub>CC</sub> = 3.0	V to 3.6V	V <sub>CC</sub> = 2.7V	1
Symbol	Parameter	Waveform	Min	Max	Max	Unit
tPLH tPHL	Propagation Delay Input to Output	1	1.5 1.5	6.0 6.0	6.5 6.5	ns
<sup>t</sup> PZH <sup>t</sup> PZL	Output Enable Time to High and Low Level	2	1.5 1.5	7.0 7.0	8.0 8.0	ns
<sup>t</sup> PHZ <sup>t</sup> PLZ	Output Disable Time From High and Low Level	2	1.5 1.5	6.0 6.0	7.0 7.0	ns
tOSHL tOSLH	Output-to-Output Skew (Note 3.)			1.0 1.0		ns

Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device.
 The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

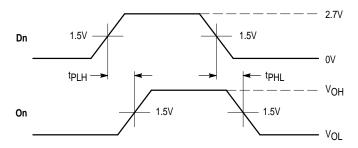
#### **DYNAMIC SWITCHING CHARACTERISTICS**

			T,	A = +25°	С	
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V <sub>OLP</sub>	Dynamic LOW Peak Voltage (Note 4.)	$V_{CC} = 3.3V$ , $C_L = 50pF$ , $V_{IH} = 3.3V$ , $V_{IL} = 0V$		0.8		V
V <sub>OLV</sub>	Dynamic LOW Valley Voltage (Note 4.)	$V_{CC} = 3.3V$ , $C_L = 50pF$ , $V_{IH} = 3.3V$ , $V_{IL} = 0V$		0.8		V

<sup>4.</sup> Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

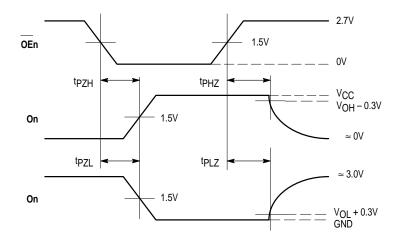
### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Parameter Condition		Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	10MHz, V <sub>CC</sub> = 3.3V, V <sub>I</sub> = 0V or V <sub>CC</sub>	25	pF



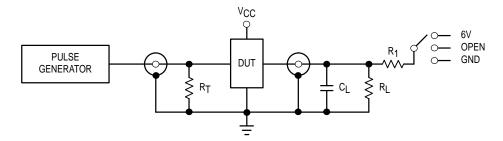
#### WAVEFORM 1 - PROPAGATION DELAYS

 $t_{\mbox{\scriptsize R}}$  =  $t_{\mbox{\scriptsize F}}$  = 2.5ns, 10% to 90%; f = 1MHz;  $t_{\mbox{\scriptsize W}}$  = 500ns



# WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES $t_R = t_F = 2.5 ns, \ 10\% \ to \ 90\%; \ f = 1 MHz; \ t_W = 500 ns$

Figure 1. AC Waveforms

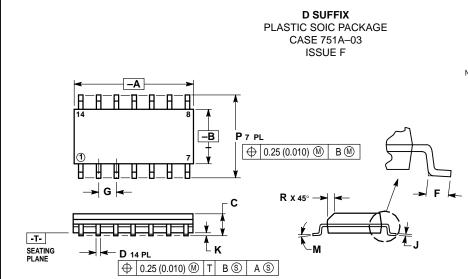


TEST	SWITCH
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
tPZL, tPLZ	6V
Open Collector/Drain t <sub>PLH</sub> and t <sub>PHL</sub>	6V
<sup>t</sup> PZH <sup>, t</sup> PHZ	GND

 $C_L$  = 50pF or equivalent (Includes jig and probe capacitance)  $R_L$  =  $R_1$  = 500 $\Omega$  or equivalent  $R_T$  =  $Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

Figure 2. Test Circuit

#### **OUTLINE DIMENSIONS**



- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- 4.
- MOLD PROTRUSION.

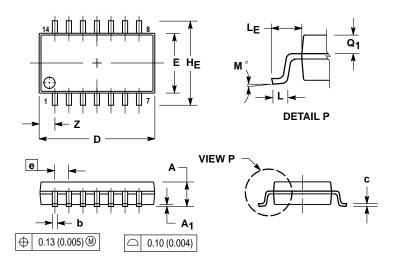
  MAXIMUM MOLD PROTRUSION 0.15 (0.006)
  PER SIDE.

  DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL
  IN EXCESS OF THE D DIMENSION AT
  MAXIMUM MATERIAL CONDITION.

	MILLIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.55	8.75	0.337	0.344
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
Р	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

#### **M SUFFIX**

PLASTIC SOIC EIAJ PACKAGE CASE 965-01 ISSUE O



#### NOTES:

- OTES:

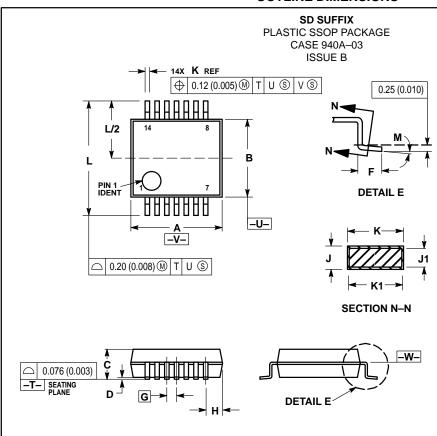
  1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2 CONTROLLING DIMENSION: MILLIMETER.

  3 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) DED SIDE. PER SIDE.
  4 TERMINAL NUMBERS ARE SHOWN FOR
- 4 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  5 THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
A		2.05	-	0.081
Α <sub>1</sub>	0.05	0.20	0.002	0.008
ь	0.35	0.50	0.014	0.020
U	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
Е	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050	BSC
ΗE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LΕ	1.10	1.50	0.043	0.059
M	0 °	10°	0 °	10°
$Q_1$	0.70	0.90	0.028	0.035
Z		1.42		0.056

#### **OUTLINE DIMENSIONS**



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: MILLIMETER.
- PROTRUCING DIMENSION, MILLIMETER.

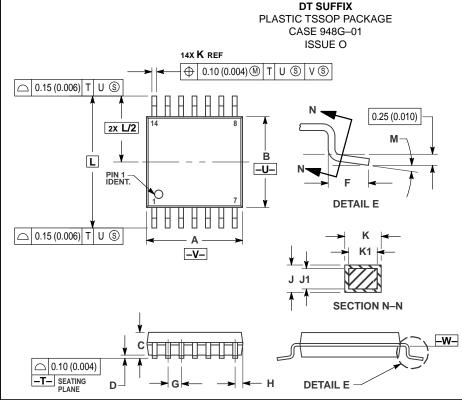
  8 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE INTERLEAD
  FLASH OR PROTRUSION. INTERLEAD FLASH OR
  PROTRUSION SHALL NOT EXCEED 0.15 (0.006)
- PROTRUSION SHALL NOT EXCEED 0.15 (0.006)
  PER SIDE.

  10 DIMENSION K DOES NOT INCLUDE DAMBAR
  PROTRUSION/INTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN
  EXCESS OF K DIMENSION AT MAXIMUM
  MATERIAL CONDITION. DAMBAR INTRUSION
  SHALL NOT REDUCE DIMENSION K BY MORE
  THAN 0.07 (0.002) AT LEAST MATERIAL
  CONDITION. CONDITION
- CONDITION.

  11 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

  12 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

_				
	MILLIN	IETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	6.07	6.33	0.238	0.249
В	5.20	5.38	0.205	0.212
С	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
Н	1.08	1.22	0.042	0.048
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
М	0 °	8°	0 °	8 °



6

#### NOTES:

- OTES:
  1 DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M, 1982.
  2 CONTROLLING DIMENSION: MILLIMETER.
  3 DIMENSION A DOES NOT INCLUDE MOLD FLASH,
  PROTRUSIONS OR GATE BURRS. MOLD FLASH,
  OR NATE BURDER CHAIR LANGE EXPERTAGE A.E.
- PROTROSIONS OR GATE BURRS. MOLE PLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15
  (0.006) PER SIDE.
  4 DIMENSION B DOES NOT INCLUDE INTERLEAD
  FLASH OR PROTRUSION. INTERLEAD FLASH OR
  PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5 DIMENSION K DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN
  EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  TERMINAL NUMBERS ARE SHOWN FOR
  REFERENCE ONLY.
  DIMENSION A AND B ARE TO BE DETERMINED
  AT DATUM PLANE –W-.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

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